

Instruction for Preparing Camera-Ready Extended Abstract for AWAD 2022

Author A Full Name¹, Author B Full Name², and Author C Full Name³

¹Department, Institution, Postal Address, Country

²Department, Institution, Postal Address, Country

³Department, Institution, Postal Address, Country

Email: e-mail address of the corresponding author

Abstract This document provides information for preparing your 2-page camera-ready paper. Please keep in mind that the abstract should be a summary of your work. A brief (100–200 words) abstract that highlights your work is required.

Keywords A few keywords should be provided here.

1. Introduction

This set of formatting instructions pertains to the preparation of a camera-ready paper for the 2022 Asia-Pacific Workshop on Fundamentals and Applications of Advanced Semiconductor Devices (AWAD2022). The extended abstract should clearly and concisely state the originality and specific results of the work. Prepare Camera-Ready paper in full size format, on A4 size (21.0 cm x 29.7 cm) paper.

2. General instructions

A. Formats

The submitted camera-ready manuscript must be written in English on two A4-size pages (including all figures and tables). Set the top, bottom, and left/right margins to 28 mm, 24 mm, and 15 mm, respectively. The first page should begin with the title, author(s), affiliation(s), address(es), and contact author's e-mail address. The title should be written in boldface and title case (i.e. all words except articles, prepositions, and conjunctions are capitalized).

Insert a blank line between the author name(s) and the abstract, and between the keyword(s) and the main text. The main text must be in two-column format with single spacing and full justification. Set the column separation to 7.5 mm. A blank line should be inserted between sections but not between paragraphs within each section. Section headings should be given in boldface.

B. Fonts

The best results will be obtained if your computer word-processor has several font sizes. Do not use fonts smaller than the fonts specified in Table I. As an aid to gauging font size, 1 point is about 0.35 mm. Use a proportional, serif font such as Times or Dutch Roman

C. Figures and Tables

A blank line should be inserted between the main text and a figure or table. Large figures and tables may span both

columns. Photographs should have high contrast in black and white. Figure captions should be placed just below their corresponding figures, while table captions should be placed above their corresponding tables

Fig. 1 This is a sample figure. Captions exceeding one line are arranged like this.

Table I FONT SIZES FOR CAMERA-READY PAPERS			
Font Size	Bold	Italic	Text
10			Main text, authors' affiliations, figure captions
10.5	Yes		Headings, i.e. section title
12			Authors' names
16	Yes		Paper title
10		Yes	Sub-headings, i.e., <i>Fonts</i>
9			References, table, table names, table captions
8			Footnotes, sub- and superscripts

D. References

References should be given in a numerical list at the end of the manuscript and cited in the main text by enclosing a reference number in square brackets (e.g. [1]).

3. Submitting the camera-ready extended abstracts

Authors are requested to submit the manuscript in both docx and pdf file format. (The AWAD paper submission system will require both Word docx and pdf files to be uploaded. Otherwise, it will generate the error message.) Please use standard English fonts such as Times New Roman and Arial, and embed all fonts to ensure that the printed document appears as intended. The manuscript should be proofread carefully beforehand in terms of spelling, grammar, and figure image quality.

The deadline for the submission of the camera-ready extended abstracts is April 8, 2022.

4. Conclusions

This is a template for the camera-ready paper of AWAD2022

Acknowledgements

This work was supported by Grant Number xxx, National Science Foundation. (example).

References

- [1] Author(s): full title of the manuscript, usual abbreviated title of the journal, volume number, page number and year.
- [2] Author(s): Proc. of 2012 Asia-Pacific Workshop on Fundamentals and Applications of Advanced Semiconductor, Daejeon, Korea, 2011, p. ##